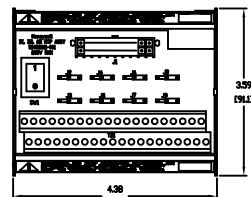
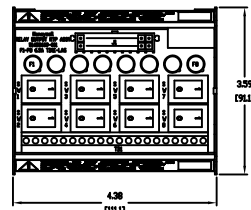


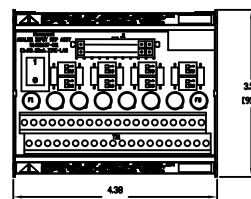
I/O Module (with door) block name: HC900-io.dwg
 I/O Module (without door-Barrier Style) block name: HC900-io-no_door.dwg
 I/O Module (without door-Euro Style) block name: HC900-io-no_door.dwg
 High Density I/O (without door-Euro Style) block name: HC900-hd-io-no_door.dwg



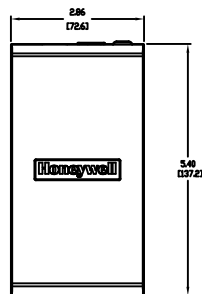
RTP MODULE ASSEMBLY
 STANDARD I/O
 RTP-MODULE-standard-I-O.dwg



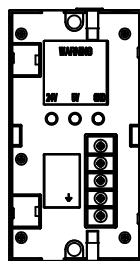
RTP MODULE ASSEMBLY
 RELAY OUTPUT
 RTP-MODULE-relay-output.dwg



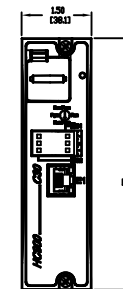
RTP MODULE ASSEMBLY
 ANALOG INPUT
 RTP-MODULE-analog-input.dwg



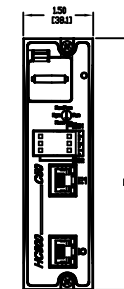
Power Supply (with door) block name: HC900-pwr_sply.dwg



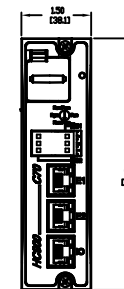
Power Supply (without door) block name: HC900-pwr_sply-no_door.dwg



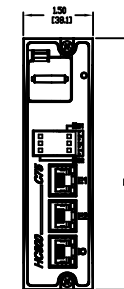
C30 CPU Module
 block name:
 HC900-C30cpu.dwg



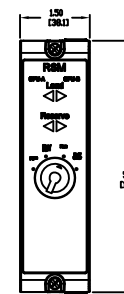
C50 CPU Module
 block name:
 HC900-C50cpu.dwg



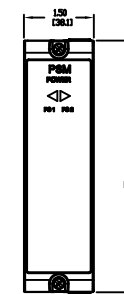
C70 CPU Module
 block name:
 HC900-C70cpu.dwg



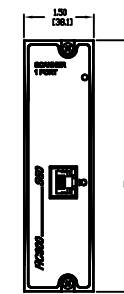
C75 CPU Module
 block name:
 HC900-C75cpu.dwg



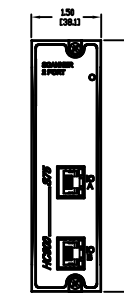
Redundant Supply Module (RSM) block name: HC900-rsmd.dwg



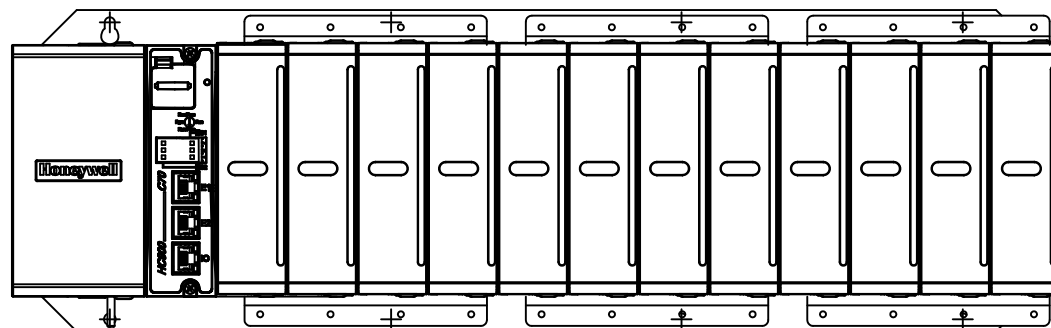
Power Status Module (PSM) block name: HC900-psmd.dwg



1 Port Scanner Module block name: HC900-scanner-1port.dwg



2 Port Scanner Module block name: HC900-scanner-2port.dwg



HC900
 12 position rack with modules
 block name: HC900-12pos.dwg

General Notes:

1. Depth of rack plus modules is 151.1mm/5.95" maximum except for the High Density I/O module which is 160.53mm/6.32".
2. Insertion point of all modules is the lower mounting screw.
3. Insertion point of all RTP modules is the lower lefthand corner.
4. To mount modules in racks insert appropriate block into rack at lower mounting screw position.
5. This drawing is layered as follows:
 0 (Object): Module outlines and general notes
 Dim: Dimensions and block specific notes
 ModuleMtg: Mounting points for modules (both on modules and in racks)

HC900 Modules

Autocad File Name: HC900_module_front_views.dwg

Revised: 05/18/18